

SAMXON BRAND ALUMINUM ELECTROLYTIC CAPACITORS PRODUCT SPECIFICATION 規格書

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CATEGORY (品名)	: ALUMINUM ELECTROLYTIC CAPACITORS
DESCRIPTION (型号)	: GT SERIES
VERSION (版本)	: 01
Customer P/N	:
SUPPLIER	:

SUPPLII	ER	CUS	ГOMER
PREPARED (拟定)	CHECKED (审核)	APPROVAL (批准)	SIGNATURE (签名)
毛彩林	刘渭清		

ELECTROLYTIC CAPACITOR SPECIFICATION GT SERIES

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	GT SERIES							
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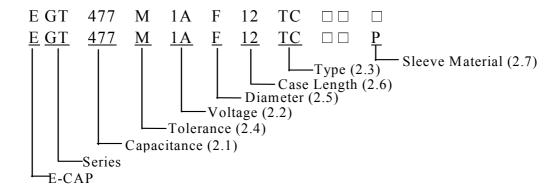
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1. Application

This specification applies to polar aluminum electrolytic capacitor (foil type) used in electronic equipment. Designed capacitor's quality meets IEC60384.

2. Part Number System



2.1 <u>Capacitance code</u>

Code	474	475	476	477	478	479
Capacitance (µF)	0.47	4.7	47	470	4700	47000

2.2 <u>Rated voltage code</u>

Code	0J	1A	1C	1E	1V	1H	1J	2A
Rate voltage (V.DC)	6.3	10	16	25	35	50	63	100

2.3 <u>Type</u>

Code	RR	TU	TU TV TC TE				HE	KD	FD
Reference	Bulk		Tapi	ng Spec			Formin	ng Spec.	

2.4 <u>Capacitance tolerance</u> "M" stands for $-20\% \sim +20\%$

2.5 <u>Diameter</u>

Code	E	F	G	Ι	K	L
Diameter	6.3	8	10	12.5	16	18

2.6 Length

2

	Code	Р	Blank			
2.7	Sleeve material			_		
	"25" stands for 25mr	n "35'	"35" stands for 35mm			
	"11" stands for 11mr	n "1B	" stands for 12.5m	m		

Sleeve material PET PVC

Remark: The " \square " in fifteenth and sixteenth digits is used for the product lines, and the " \square " in the seventeenth digit is used to indicate that the sleeve is the PVC material.

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3.Construction

No

1

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3

4

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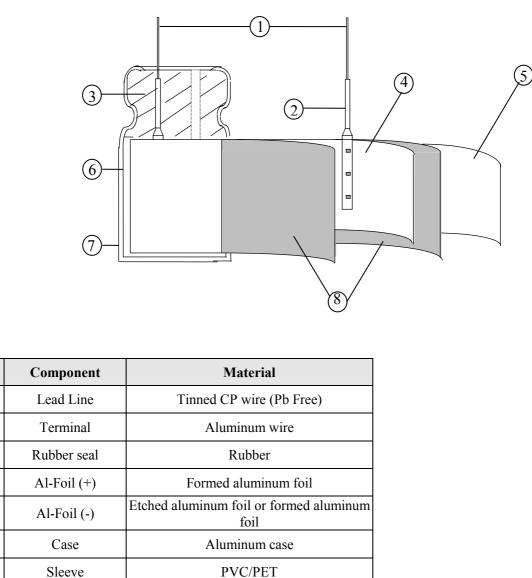
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7

8

Separator

Single ended type to be produced to fix the terminals to anode and cathode foil, and wind together with paper, and then wound element to be impregnated with electrolyte will be enclosed in an aluminum case. Finally sealed up tightly with end seal rubber, then finished by putting on the vinyl sleeve.



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Electrolyte paper

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4. Characteristics

Standard atmospheric conditions

Unless otherwise specified, the standard range of atmospheric conditions for making measurements and tests is as follows:

Ambient temperature	:15°C to 35°C
Relative humidity	: 45% to 85%
Air pressure	: 86kPa to 106kPa

If there is any doubt about the results, measurement shall be made within the following conditions:Ambient temperature: $20^{\circ}C \pm 2^{\circ}C$ Relative humidity: 60% to 70%Air pressure: 86kPa to 106kPa

Operating temperature range

The ambient temperature range at which the capacitor can be operated continuously at rated voltage is -40°C to 105°C.

As to the detailed information, please refer to table 1.

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	ITEM	PERFORMANCE									
	Rated voltage (WV)	WV (V.DC)	6.3	10	16	25	35	5	0	63	100
4.1	Surge voltage (SV)	SV (V.DC)	8	13	20	32	44	. 6	3	79	125
4.2	Nominal capacitance (Tolerance)	<condition> Measuring frequ Measuring volta Measuring temp <criteria> Shall be within t</criteria></condition>	nge berature	: Not m $20\pm2^{\circ}$	ore tha	n 0.5V					
4.3	Leakage current	<condition> Connecting the minutes, and the <criteria> I (µ A)≤0.01CV I: Leakage curren C: Capacitance (V: Rated DC wo</criteria></condition>	n, measu V or 3 (µ nt (µ A) µ F)	re Leaka A) whic	nge Cur	rent.		(1k Ω ±	<u>-</u> 10 Ω) in ser	ies for
4.4	Tan δ	<condition> See 4.2, Norm ca <criteria> Working volt</criteria></condition>	tage (v)	6.3	10	16	25	35	50	63	100
		Tan δ (max.)0.220.190.160.140.120.100.090.08For capacitance value >1000 μ F, add 0.02 per another 1000 μ F.									
4.5	Impedance	<condition> Measuring freque Measuring point <criteria> (20°C)Less than</criteria></condition>	: 2mm m	ax from	the sur	face of	a sealir			he lead	wire.

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4.6	Terminal strength	Fixed the ca 1 seconds. Bending str Fixed the ca for 90° with 2~3 second Diamete 0.5m Over 0.5	ngth of terminals apacitor, applied f rength of terminal apacitor, applied f in 2~3 seconds, a s. er of lead wire am and less form to 0.8mm	s. orce to bent nd then ben Tensile f 5 10	the terminal (t it for 90° to it orce N (kgf) (0.51) (1.0)	ad out direction for 10± 1~4 mm from the rubber) s original position within Bending force N (kgf) 2.5 (0.25) 5 (0.51) ooseness at the terminal.
		< <u>Condition</u> <u>STEP</u> <u>1</u> <u>2</u> <u>3</u> <u>4</u> <u>5</u> < <u>Criteria</u> a. At +105℃	Testing temper 20±2 -40 (-25) 20±2 105±2 20±2	±3 2	Time to reach Time to reach Time to reach Time to reach	Timeh thermal equilibriumh thermal equilibriumh thermal equilibriumh thermal equilibriumh thermal equilibriumh thermal equilibriumwithin $\pm 20\%$
4.7	Temperature characteristics	of its origi Tan δ sha The leaka value. b. In step 5, 7	nal value. Il be within the lin	nit of Item red shall n hin the lim	4.4 tot more than tof Item 4.4	8 times of its specified

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		Working Voltage (V)	6.3	10	16	25	35	50	63	100
4.7		Z-25℃/Z+20℃	4	3	2	2	2	2	2	2
		Z-40°C/Z+20°C	8	6	4	3	3	3	3	3
		Capacitance, Tan δ , and i	impeda	nce sha	all be n	neasure	ed at 12	20Hz.		1
4.8	Load life test	<condition>According to IEC60384- is stored at a temperature rated ripple current for 6. $8 \sim \phi 10$) hours,8000+48/ hours,7000 +48/0($\phi 8 \sim \phi$ and ripple peak voltage product should be test conditions. The result sh<criteria> The characteristic shall mLeakage current Capacitance Change Tan δ Appearance</br></criteria></br></condition>	e of 10: $3\sim10W$ $(0(\oplus 12))$ $(0(\oplus 12))$ $(0(\oplus 12))$ (0) $(0)(0)$ $(0)(0)$ $(0)(0)$ $(0)(0)$ $(0)(0)$ $(0)(0)$ (0) $(0)(0)$ (0) $(0)(0)$ (0) $(0)(0)$ (0) $(0)(0)$ (0) (0) $(0)(0)$ (0) (0) $(0)(0)$ (0) (0) $(0)(0)$ (0) (0) $(0)(0)$ (0) (0) (0) (0) $(0)(0)$ (0) $(0$	$5 \pm 2^{\circ}$ V: 40(2.5) hor purs,10 not exc er 16 eet the follow ue in 4 hin ± 1 more	C with 00+48/ urs; 16 000 +4 eed the hours follow <u>ing req</u> .3 shal 25% of than 20	DC bi $0(\phi 5 \sim -100W)$ $(\phi \phi = -100W)$	as volta (\$\phi 6.3) (V: 50 12.5)h worki ering le: ents. isfied l value the spe	00 +48 00 +48 ours. (1 ng volt time a	6000 + β/0(φ 5 Γhe sur tage) T tt atmost value.	$\sim \Phi 6.3$ n of DC then the
4.9	Shelf life test	<condition>The capacitors are then stor $^{\circ}C$ for 1000+48/0 hours.Following this period the c allowed to stabilized at roc Next they shall be connect rated voltage applied for 30 then, tested the characterist<criteria>The characteristic shall m Leakage current Capacitance Change Tan $^{\delta}$ AppearanceRemark: If the capacitor increase. Please</criteria></condition>	apacito om tem ited to Omin. A tics. <u>neet the</u> Value Withi Not m There s are st	rs shall peratur a serie fter wh <u>follow</u> in 4.3 n ± 25 pore that shall b ored m	l be rer e for 4 s limit nich the <u>ving rec</u> shall b % of i an 2009 pe no le ore tha	noved f ~8 hou ing res capaci capaci e satisf nitial v %of the eakage in 1 yea	from th rs. istor(1) itors sh ents. fied alue. e specif of elec ar, the 1	the test c $k \pm 100$ hall be c fied val trolyte. leakage	hambe)Ω) wi lischarg	r and b ith D.C ged, and

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4.10	Surge test	<condition> Applied a surge voltage to the capacitor connected with a $(100 \pm 50)/C_R (k\Omega)$ resistor. The capacitor shall be submitted to 1000 cycles, each consisting of charge of 30 $\pm 5s$, followed discharge of 5 min 30s. The test temperature shall be $15\sim35^{\circ}C$. C_R :Nominal Capacitance (μ F) <criteria>Leakage currentNot more than the specified value. Tapearancetan δNot more than the specified value.AppearanceThere shall be no leakage of electrolyte.Attention: This test simulates over voltage at abnormal situation only. It is not applicable to such over voltage as often applied.</criteria></br></condition>
4.11	Vibration test	Condition> The following conditions shall be applied for 2 hours in each 3 mutually perpendicular directions. Vibration frequency range : 10Hz ~ 55Hz Peak to peak amplitude : 1.5mm Sweep rate : 10Hz ~ 55Hz ~ 10Hz in about 1 minute Mounting method: The capacitor with diameter greater than 12.5mm or longer than 25mm must be fixed in place with a bracket. Within 30° 4mm or less Vibration provide the solution of the sol

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		<criteria></criteria>	
		After the test, the follow	
		Inner construction	No intermittent contacts, open or short circuiting. No damage of tab terminals or electrodes.
		Appearance	No mechanical damage in terminal. No leakage of electrolyte or swelling of the case. The markings shall be legible.
		<condition></condition>	
			ed under the following conditions:
		Soldering temperature	: 245±3°C
		Dipping depth	: 245±5 °C
		Dipping speed	: 25±2.5mm/s
	Solderability test	Dipping speed Dipping time	: 3±0.5s
		Dipping time	. 5±0.38
4.12		<criteria></criteria>	
			A minimum of 95% of the surface
		Coating quality	being immersed
		<condition></condition>	
			citor shall be immersed into solder bath at
		-	
			1 seconds or 400 ± 10 °C for 3_{-0}^{+1} seconds t
		$1.5 \sim 2.0$ mm from the	body of capacitor.
		Then the capacitor sh	hall be left under the normal temperature and
			$1 \sim 2$ hours before measurement.
		<criteria></criteria>	
	Resistance to		Not more than the specified value.
4.13	solder heat	Capacitance Change	Within $\pm 10\%$ of initial value.
	test	Tan δ	Not more than the specified value.
		Appearance	There shall be no leakage of electrolyte.
		Appearance	There shall be no reakage of electrolyte.

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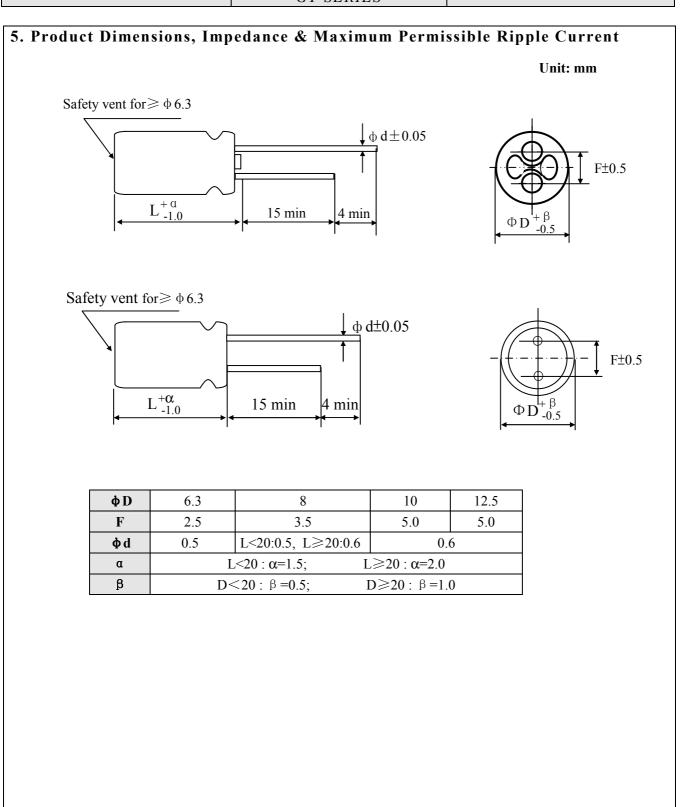
oven, the condition according as below:Temperature(1)+20°C(2)Rated low temperature (-40°C) (-25(3)Rated high temperature (+105°C)	Time ≤3 Minutes
(2)Rated low temperature (-40°C) (-25 (3)Rated high temperature (+105°C)	
(3)Rated high temperature (+105°C)	5° 30+2 Minutes
	50 ± 2 willians
	30 ± 2 Minutes
Change of (1) to (3)=1 cycle, total 5 cycle	
Tan δ Not more that	ng requirement. an the specified value. an the specified value. be no leakage of electrolyte.
<condition> Humidity Test: According to IEC60384-4No.4.12method ± 8 hours in an atmosphere of 90~95% change shall meet the following require <criteria></criteria></condition>	R H. at 40 ± 2 °C, the characteristic
	the specified value.
	of initial value.
test	120% of the specified value.
Appearance There shall be	no leakage of electrolyte.

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		Condition> The following test only app $\geq \emptyset 6.3$ with vent.	ly to the	ose produ	cts with	vent proc	lucts at dian	nete
		D.C. test The capacitor is connected a current selected from Tab			versed to	a DC pov	wer source. T	Ther
4.16	Vent test	<table 2=""></table>						
4.10	test		Current	(A)				
		22.4 or less	1					
		<criteria></criteria> The vent shall operate with of pieces of the capacitor as			litions su	ich as flar	nes or disper	rsioı
		<condition> The maximum permissible ri at 100kHz and can be applied Table-3 The combined value of D.C rated voltage and shall not no Frequency Multipliers: Coefficient</condition>	ed at max voltage a	ximum op and the pe	erating t	emperatu	re	d the
		(Hz)	50	120	300	1k	100k	
	Maximum permissible	Cap. (µ F)						
4.17	(ripple	15~33	0.45	0.55	0.70	0.90	1.00	
4.17	current,	<u>39~330</u> <u>390~1000</u>	0.60	0.70	0.85	0.95 0.98	1.00	
	temperature coefficient)	1200~3900	0.03	0.73	0.90	1.00	1.00	
	coefficienty	Temperature Coefficie						
		Temperature (°C)	85	95	105			
		Factor	1.73	1.41	1.00			

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Table-3		1												
Voltage (Code)			6.3V(0J)		10V(1A)									
$Cop(\mu E)$	Code	Case size	Impedance	Ripple Current	Case size	Impedance	Ripple Current							
Cap. (µF)	Code	$\phi D \times L(mm)$	(Ω)	(mA rms)	ϕ D×L(mm)	(Ω)	(mA rms)							
220	227				6.3x11	0.220	340							
330	337	6.3x11	0.220	340										
470	477				8x12	0.130	640							
680	687	8x12	0.130	0.130 640		0.087	840							
080	08/	8X12	0.150	040	10x12.5	0.080	865							
820	827	10x12.5	0.080	865										
					<u></u> ∆8x16	0.087	840							
1000	108	8x16	0.087	0.087	0.087	0.087	0.087	0.087	0.087	0.087	840	8x20	0.069	1050
					10x16	0.060	1210							
1200	128	8x20	0.069	1050	10x20	0.046	1400							
1200	120	10x16	0.060	1210	10x20	0.040	1400							
1500	158	10x20	0.046	1400	10x25	0.042	1650							
2200	228	10x25	0.042	1650	10x30	0.031	1910							
2200	228	10x25	0.042	1650	12.5x20	0.035	1900							
2700	278	10x30	0.031	1910										
3300	338	12.5x20	0.035	1900	12.5x25	0.030	2124							
3900	398	12.5x25	0.030	2124										

Maximum Allowable Ripple Current (mA rms) at 105°C100kHz Maximum Impedance(Ω) at 20°C100kHz

Case Size Φ DxL(mm)

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Voltage (Code)			16V(1C)		25V(1E)			
Cap. (µF)	Code	Case size $\phi D \times L(mm)$	Impedance (Ω)	Ripple Current (mA rms)	Case size $\phi D \times L(mm)$	Impedance (Ω)	Ripple Current (mA rms)	
100	107				6.3x11	0.220	340	
120	127	6.3x11	0.220	340				
150	157							
220	227				8x12	0.130	640	
330	337	8x12	0.130	640	8x16	0.087	840	
550	557	8X12	0.130	040	10x12.5	0.080	865	
		8x16	0.087	840	8x20	0.069	1050	
470	477	10x12.5	0.080	865	10x16	0.060	1210	
(90	(07	8x20	0.069	1050	1020	0.046	1400	
680	687	10x16	0.060	1210	10x20	0.046		
820	827				10x25	0.042	1650	
					<u>∕</u> 10x20	0.046	1400	
1000	108	10x20	0.046	1400	10x30	0.031	1910	
					12.5x20	0.035	1900	
1200	128	10x25	0.042	1650				
1500	158	10x30	0.031	1910	12.5x25	0.030	2124	
1300	138	12.5x20	0.035	1900	12.3823	0.030	2124	
2200	228	12.5x25	0.030	2124				

220022812.5x250.0302Maximum Allowable Ripple Current (mA rms) at 105 $^{\circ}$ C100kHzMaximum Impedance(Ω) at 20 $^{\circ}$ C100kHz

Case Size Φ DxL(mm)

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Voltage (Code)			35V(1V)		50V(1H)			
Cap. (µF)	Code	Case size	Impedance	Ripple Current	Case size	Impedance	Ripple Current	
	Coue	$\phi D \times L(mm)$	(Ω)	(mA rms)	$\phi D \times L(mm)$	(Ω)	(mA rms)	
56	566	6.3x11	0.220	340	6.3x11	0.300	295	
100	107				8x12	0.170	555	
120	127				8x16	0.120	730	
150	157	8x12	0.130	640	10x12.5	0.120	760	
220	227	8x16	0.087	840	10x16	0.084	1050	
220		10x12.5	0.080	865	10x16	0.084	1030	
330	337	10x16	0.060	1210	10x25	0.055	1440	
470	477	10x20	0.046	1400	10x30	0.043	1690	
470	4//	10X20	0.040	1400	12.5x20	0.045	1660	
560	567	10x25	0.042	1650	12.5x25	0.034	1950	
680	687	10x30	0.031	1910				
080	007	12.5x20	0.035	1900				
1000	108	12.5x25	0.030	2124				

Maximum Allowable Ripple Current (mA rms) at 105°C100kHz Maximum Impedance(Ω) at 20°C100kHz

Case Size Φ DxL(mm)

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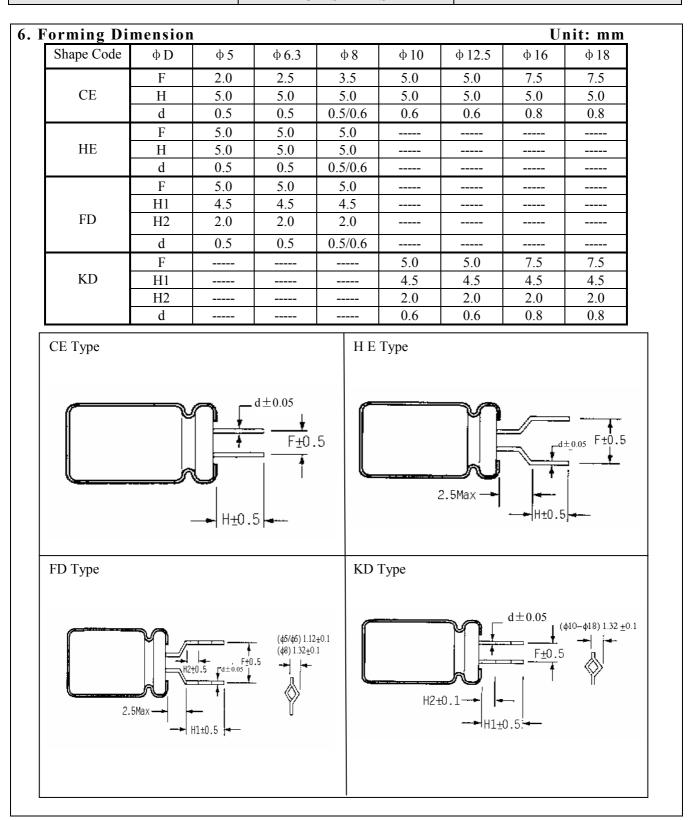
Voltage (Voltage (Code)		63V(1J)		100V(2A)			
Cap. (µF)	Code	Case size $\phi D \times L(mm)$	Impedance (Ω)	Ripple Current (mA rms)	Case size $\phi D \times L(mm)$	Impedance (Ω)	Ripple Current (mA rms)	
15	156				6.3x11	0.960	115	
27	276				8x12	0.504	232	
33	336	6.3x11	0.960	115				
39	396				8x16	0.360	300	
47	476				10x12.5	0.344	314	
56	566	8x12	0.504	232	8x20	0.264	362	
68	686				10x16	0.248	357	
82	826	8x16 10x12.5	0.360 0.344	300 314	10x20	0.168	466	
100	107				10x25	0.160	531	
120	107	8x20	0.264	362	10x30	0.120	663	
120	127	10x16	0.248	357	12.5x20	0.128	690	
180	187	10x20	0.168	466	12.5x25	0.096	922	
220	227	10x25	0.160	531				
270	277	10x30	0.120	663				
270	211	12.5x20	0.128	690				
330	337	12.5x25	0.096	922				

Maximum Allowable Ripple Current (mA rms) at 105°C100kHz Maximum Impedance(Ω) at 20°C100kHz Case Size Φ DxL(mm)

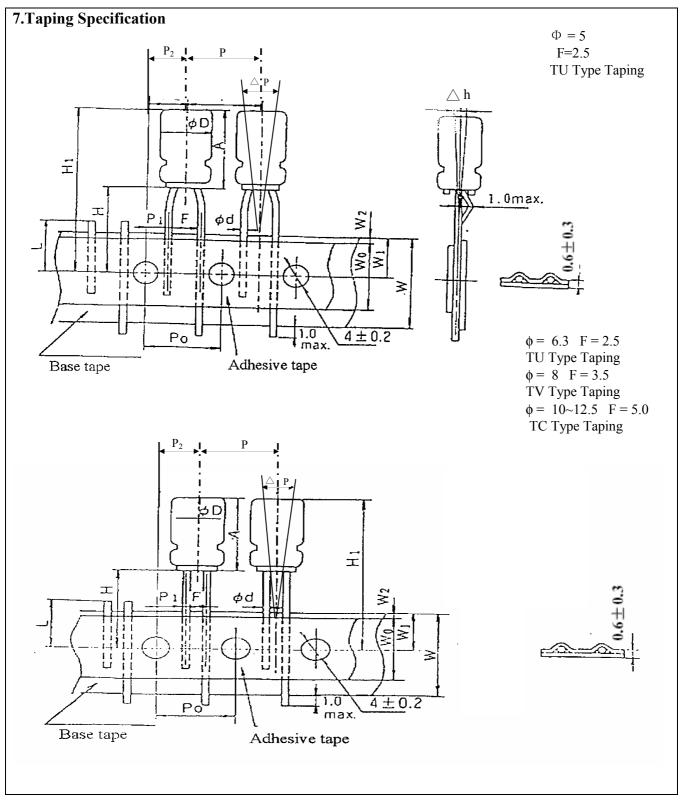
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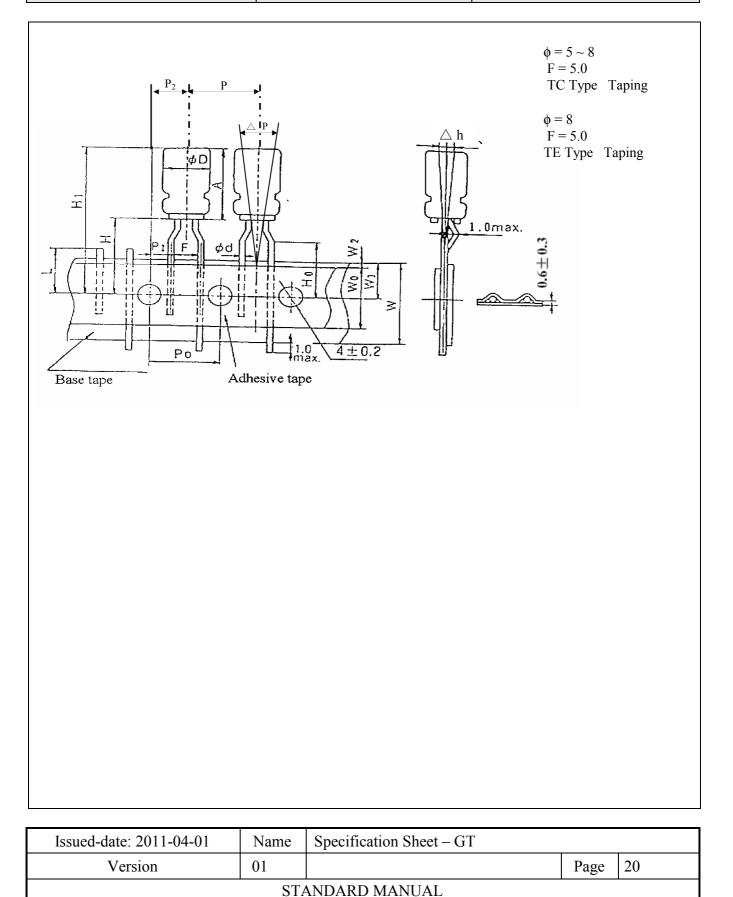


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emark: Maximum Taping		n: 18mm	Diamet	ter					Unit: mm
Item	Code	Т	U	TV		ТС	2		TE
Diameter	D	5	6.3	8	5 / 6.3	8	10	12.5	8
Height	А	9~15	9~15	10~20	9~15	10~20	9~30	15~35	10~20
Lead Diameter	$d\!\pm\!0.05$	0.5	0.5	0.5/0.6	0.5	0.5/0.6	0.6	0.6	0.5/0.6
Component Spacing	$P\pm1.0$	12.7	12.7	12.7	12.7	12.7	12.7	15	12.7
Pitch of sprocket holes	$P_0\!\pm\!0.2$	12.7	12.7	12.7	12.7	12.7	12.7	15	12.7
Distance between centers of terminal	$P_1 \pm 0.5$	5.1	5.1	4.6	3.85	3.85	3.85	5.0	3.85
Feed hole center to component center	$P_2 \pm 1.0$			6	.35			7.5	6.35
Distance between centers of component leads	$F_{-0.2}^{+0.8}$	2.5	2.5	3.5	5.0	5.0	5.0	5.0	5.0
Carrier tape width	$W_{-0.5}^{+1}$	18	18	18	18	18	18	18	18
Hold down tape width	W_0			71	nin			15min	7min
Distance between the center of upper edge of carrier tape and sprocket hole	$W_1 \pm 0.5$	9	9	9	9	9	9	9	9
Distance between the upper edges of the carrier tape and the hold down tape	W ₂					3max			
Distance between the abscissa and the bottom of the components body	+0.75 H _0.5	18.5	18.5	18.5	18.5	20.0	18.5	18.5	18.5
Distance between the abscissa and the reference plane of the components with crimped leads	$H_0 \pm 0.5$				16	16			16
Cut off position of defectives	L					11 max			
Max. lateral deviation of the component body vertical to the tape plane	riangle h					2 max			
Max. deviation of the component body in the tape plane	△P					1.3 max			

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8. List of "Environment-related Substances to be Controlled ('Controlled Substances')"

The latest version of <Substances Prohibited as per Sony-SS-00259>

	Substances					
	Cadmium and cadmium compounds					
Heavy metals	Lead and lead compounds					
ficavy metals	Mercury and mercury compounds					
	Hexavalent chromium compounds					
	Polychlorinated biphenyls (PCB)					
Chloinated	Polychlorinated naphthalenes (PCN)					
organic	Polychlorinated terphenyls (PCT)					
compounds	Short-chain chlorinated paraffins(SCCP)					
	Other chlorinated organic compounds					
	Polybrominated biphenyls (PBB)					
Brominated	Polybrominated diphenylethers(PBDE) (including decabromodiphenyl					
organic	ether[DecaBDE])					
compounds	Other brominated organic compounds					
Tributyltin comp	ounds(TBT)					
Triphenyltin com	apounds(TPT)					
Asbestos						
Specific azo com	pounds					
Formaldehyde						
Beryllium oxide						
Beryllium copp	er					
Specific phthalat	es (DEHP,DBP,BBP,DINP,DIDP,DNOP,DNHP)					
Hydrofluorocarb	on (HFC), Perfluorocarbon (PFC)					
Perfluorooctane	sulfonates (PFOS)					
Specific Benzotr	iazole					

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Attachment: Application Guidelines

1.Circuit Design

1.1 Operating Temperature and Frequency

Electrolytic capacitor electrical parameters are normally specified at 20° C temperature and 120Hz frequency. These parameters vary with changes in temperature and frequency. Circuit designers should take these changes into consideration.

- (1) Effects of operating temperature on electrical parameters
 - a) At higher temperatures, leakage current and capacitance increase while equivalent series resistance (ESR) decreases.
 - b) At lower temperatures, leakage current and capacitance decrease while equivalent series resistance (ESR) increases.
- (2) Effects of frequency on electrical parameters
 - a) At higher frequencies capacitance and impedance decrease while tan δ increases.
 - b) At lower frequencies, ripple current generated heat will rise due to an increase in equivalent series resistance (ESR).
- 1.2 Operating Temperature and Life Expectancy See the file: Life calculation of aluminum electrolytic capacitor
- 1.3 Common Application Conditions to Avoid The following misapplication load conditions will cause rapid deterioration to capacitor electrical parameters. In addition, rapid heating and gas generation within the capacitor can occur causing the pressure relief vent to operate and resultant leakage of electrolyte. Under Leaking electrolyte is combustible and electrically conductive.

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(1) Reverse Voltage

DC capacitors have polarity. Verify correct polarity before insertion. For circuits with changing or uncertain polarity, use DC bipolar capacitors. DC bipolar capacitors are not suitable for use in AC circuits.

(2) Charge / Discharge Applications

Standard capacitors are not suitable for use in repeating charge / discharge applications. For charge / discharge applications consult us and advise actual conditions.

(3) Over voltage

Do not apply voltages exceeding the maximum specified rated voltage. Voltages up to the surge voltage rating are acceptable for short periods of time. Ensure that the sum of the DC voltage and the superimposed AC ripple voltage does not exceed the rated voltage.

(4) Ripple Current

Do not apply ripple currents exceeding the maximum specified value. For high ripple current applications, use a capacitor designed for high ripple currents or contact us with your requirements. Ensure that allowable ripple currents superimposed on low DC bias voltages do not cause reverse voltage conditions.

- 1.4 Using Two or More Capacitors in Series or Parallel
- (1) Capacitors Connected in Parallel

The circuit resistance can closely approximate the series resistance of the capacitor causing an imbalance of ripple current loads within the capacitors. Careful design of wiring methods can minimize the possibility of excessive ripple currents applied to a capacitor.

- (2) Capacitors Connected in Series Normal DC leakage current differences among capacitors can cause voltage imbalances. The use of voltage divider shunt resistors with consideration to leakage current can prevent capacitor voltage imbalances.
- 1.5 Capacitor Mounting Considerations
- (1) Double Sided Circuit Boards

Avoid wiring pattern runs, which pass between the mounted capacitor and the circuit board. When dipping into a solder bath, excess solder may collect under the capacitor by capillary action and short circuit the anode and cathode terminals.

(2)Circuit Board Hole Positioning

The vinyl sleeve of the capacitor can be damaged if solder passes through a lead hole for subsequently processed parts. Special care when locating hole positions in proximity to capacitors is recommended.

(3)Circuit Board Hole Spacing

The circuit board holes spacing should match the capacitor lead wire spacing within the specified tolerances. Incorrect spacing can cause excessive lead wire stress during the insertion process. This may result in premature capacitor failure due to short or open circuit, increased leakage current, or electrolyte leakage.

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 (4) Clearance for Case Mounted Pressure Relief vents Capacitors with case mounted pressure relief vents require sufficient clearance to allow for proper vent operation. The minimum clearances are dependent on capacitor diameters as proper vent operation. The minimum clearances are dependent on capacitor diameters as follows. \$\phi 6.3\screw \phi 16mm;2mm minimum, \$\phi 18\screw \phi 35mm;3mm minimum, \$\phi 40mm or greater;5mm minimum.
(5) Clearance for Seal Mounted Pressure Relief Vents A hole in the circuit board directly under the seal vent location is required to allow proper release of pressure.
(6) Wiring Near the Pressure Relief Vent Avoid locating high voltage or high current wiring or circuit board paths above the pressure relief vent. Flammable, high temperature gas exceeding 100°C may be released which could dissolve the wire insulation and ignite.
(7) Circuit Board patterns Under the Capacitor Avoid circuit board runs under the capacitor as electrolyte leakage could cause an electrical short.
(8) Screw Terminal Capacitor Mounting Do not orient the capacitor with the screw terminal side of the capacitor facing downwards. Tighten the terminal and mounting bracket screws within the torque range specified in the specification.
 Electrical Isolation of the Capacitor Completely isolate the capacitor as follows. Between the cathode and the case (except for axially leaded B types) and between the anode terminal and other circuit paths Between the extra mounting terminals (on T types) and the anode terminal, cathode terminal, and other circuit paths.
1.7 The Product endurance should take the sample as the standard.
1.8 If conduct the load or shelf life test, must be collect date code within 6 months products of sampling.
1.9 Capacitor Sleeve The vinyl sleeve or laminate coating is intended for marking and identification purposes and is not meant to electrically insulate the capacitor. The sleeve may split or crack if immersed into solvents such as toluene or xylene, and then exposed to high temperatures.
CAUTION! Always consider safety when designing equipment and circuits. Plan for worst case failure modes such as short circuits and open circuits which could occur during use. (1) Provide protection circuits and protection devices to allow safe failure modes. (2) Design redundant or secondary circuits where possible to assure continued operation in case of main circuit failure.

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2. Capacitor Handling Techniques

- 2.1 Considerations Before Using
- (1) Capacitors have a finite life. Do not reuse or recycle capacitors from used equipment.
- (2) Transient recovery voltage may be generated in the capacitor due to dielectric absorption. If required, this voltage can be discharged with a resistor with a value of about $1k \Omega$.
- (3) Capacitors stored for long periods of time may exhibit an increase in leakage current. This can be corrected by gradually applying rated voltage in series with a resistor of approximately $1k\Omega$.
- (4) If capacitors are dropped, they can be damaged mechanically or electrically. Avoid using dropped capacitors.
- (5) Dented or crushed capacitors should not be used. The seal integrity can be compromised and loss of electrolyte / shortened life can result.
- 2.2 Capacitor Insertion
- * (1) Verify the correct capacitance and rated voltage of the capacitor.
- * (2) Verify the correct polarity of the capacitor before inserting.
- * (3) Verify the correct hole spacing before insertion (land pattern size on chip type) to avoid stress on the terminals.
 (4) Ensure that the auto insertion equipment lead clinching operation does not stress the capacitor leads where they enter the seal of the capacitor.

For chip type capacitors, excessive mounting pressure can cause high leakage current, short circuit, or disconnection.

2.3 Manual Soldering

- (1) Observe temperature and time soldering specifications or do not exceed temperatures of 400 $^{\circ}$ C for 3 seconds or less.
- (2) If lead wires must be formed to meet terminal board hole spacing, avoid stress on the lead wire where it enters the capacitor seal.
- (3) If a soldered capacitor must be removed and reinserted, avoid excessive stress to the capacitor leads.
- (4) Avoid touching the tip of the soldering iron to the capacitor, to prevent melting of the vinyl sleeve.

2.4 Flow Soldering

- (1) Do not immerse the capacitor body into the solder bath as excessive internal pressure could result.
- (2) Observe proper soldering conditions (temperature, time, etc.) Do not exceed the specified limits.
- (3) Do not allow other parts or components to touch the capacitor during soldering.

2.5 Other Soldering Considerations

Rapid temperature rises during the preheat operation and resin bonding operation can cause cracking of the capacitor vinyl sleeve.

For heat curing, do not exceed 150°C for a maximum time of 2 minutes.

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2.6 Capacitor Handling after Solder

- (1). Avoid movement of the capacitor after soldering to prevent excessive stress on the lead wires where they enter the seal.
- (2). Do not use capacitor as a handle when moving the circuit board assembly.
- (3). Avoid striking the capacitor after assembly to prevent failure due to excessive shock.

2.7 Circuit Board Cleaning

- * (1) Circuit boards can be immersed or ultrasonically cleaned using suitable cleaning solvents for up 5 minutes and up to 60°C maximum temperatures. The boards should be thoroughly rinsed and dried.
- The use of ozone depleting cleaning agents is not recommended in the interest of protecting the environment.
- * (2) Avoid using the following solvent groups unless specifically allowed for in the specification;
- Halogenated cleaning solvents: except for solvent resistant capacitor types, halogenated solvents can permeate the seal and cause internal capacitor corrosion and failure. For solvent resistant capacitors, carefully follow the temperature and time requirements of the specification. 1-1-1 trichloroethane should never be used on any aluminum electrolytic capacitor.
- Alkali solvents : could attack and dissolve the aluminum case.
- . Petroleum based solvents: deterioration of the rubber seal could result.
- . Xylene : deterioration of the rubber seal could result.
- Acetone : removal of the ink markings on the vinyl sleeve could result.
- * (3) A thorough drying after cleaning is required to remove residual cleaning solvents which may be trapped between the capacitor and the circuit board. Avoid drying temperatures, which exceed the maximum rated temperature of the capacitor.
- * (4) Monitor the contamination levels of the cleaning solvents during use by electrical conductivity, pH, specific gravity, or water content. Chlorine levels can rise with contamination and adversely affect the performance of the capacitor.

Please consult us for additional information about acceptable cleaning solvents or cleaning methods.

2.8 Mounting Adhesives and Coating Agents

When using mounting adhesives or coating agents to control humidity, avoid using materials containing halogenated solvents. Also, avoid the use of chloroprene based polymers.

After applying adhesives or coatings, dry thoroughly to prevent residual solvents from being trapped between the capacitor and the circuit board.

3. Precautions for using capacitors

3.1 Environmental Conditions

Capacitors should not be stored or used in the following environments.

- * (1) Temperature exposure above the maximum rated or below the minimum rated temperature of the capacitor.
- * (2) Direct contact with water, salt water, or oil.
- * (3) High humidity conditions where water could condense on the capacitor.

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- * (4) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid chlorine, or ammonia.
- * (5) Exposure to ozone, radiation, or ultraviolet rays.
- * (6) Vibration and shock conditions exceeding specified requirements.

3.2 Electrical Precautions

- (1) Avoid touching the terminals of the capacitor as possible electric shock could result. The exposed aluminum case is not insulated and could also cause electric shock if touched.
- (2) Avoid short circuit the area between the capacitor terminals with conductive materials including liquids such as acids or alkaline solutions.

4. Emergency Procedures

- (1) If the pressure relief vent of the capacitor operates, immediately turn off the equipment and disconnect form the power source. This will minimize additional damage caused by the vaporizing electrolyte.
- (2) Avoid contact with the escaping electrolyte gas which can exceed 100°C temperatures. If electrolyte or gas enters the eye, immediately flush the eyes with large amounts of water. If electrolyte or gas is ingested by month, gargle with water. If electrolyte contacts the skin, wash with soap and water.

5. Long Term Storage

Leakage current of a capacitor increases with long storage times. The aluminum oxide film deteriorates as a function of temperature and time. If used without reconditioning, an abnormally high current will be required to restore the oxide film. This current surge could cause the circuit or the capacitor to fail.

After one year, a capacitor should be reconditioned by applying rated voltage in series with a 1000Ω , current limiting resistor for a time period of 30 minutes .

If the expired date of products date code is over eighteen months, the products should be return to confirmation. 5.1 Environmental Conditions

The capacitor shall be not use in the following condition:

- (1) Temperature exposure above the maximum rated or below the minimum rated temperature of the capacitor.
- (2) Direct contact with water, salt water, or oil.
- (3) High humidity conditions where water could condense on the capacitor.
- (4) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid, chlorine, or ammonia.
- (5) Exposure to ozone, radiation, or ultraviolet rays.
- (6) Vibration and shock conditions exceeding specified requirements.

6. Capacitor Disposal

- When disposing of capacitors, use one of the following methods.
- * Incinerate after crushing the capacitor or puncturing the can wall (to prevent explosion due to internal pressure rise). Capacitors should be incinerated at high temperatures to prevent the release of toxic gases such as chlorine from the polyvinyl chloride sleeve, etc.

* Dispose of as solid waste. NOTE: Local laws may have specific disposal requirements, which must be followed.

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